

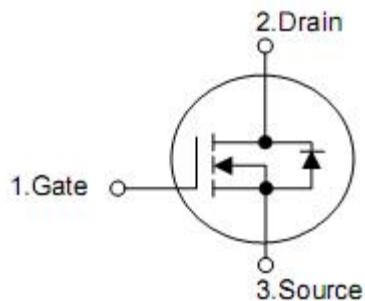
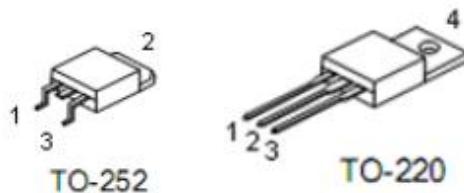
1. General Description

KIA50N06C is an N-channel enhancement mode power Mosfet field effect transistor which is produced using KIA's LVMosfet technology. the improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance. This device is widely used in UPS, Power Management for Inverter Systems.

2. Features

- 50A, 60V, $R_{DS(on)}$ typ. = $11\text{m}\Omega$ (typ.)@ $V_{GS} = 10\text{ V}$
- Low gate charge
- Low C_{rss}
- Fast switching
- Improved dv/dt capability

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

4. Ordering Information

Part Number	Package	Brand
KIA50N06CD	TO-252	KIA
KIA50N06CP	TO-220	KIA

5. Absolute maximum ratings

($T_C = 25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Ratings		Units
		TO-252	TO-220	
V_{DSS}	Drain-Source Voltage	60		V
I_D	Drain Current -Continuous ($T_C = 25^\circ\text{C}$)	50		A
	-Continuous ($T_C = 100^\circ\text{C}$)	30		A
I_{DM}	Drain Current -Pulsed	200		A
V_{GSS}	Gate-Source Voltage	± 20		V
E_{AS}	Single Pulsed Avalanche Energy (Note 1)	405		mJ
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	90	110	W
	-Derate above 25°C	0.72	0.88	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$

6. Thermal Characteristics

Symbol	Parameter	Ratings		Units
		TO-252	TO-220	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.39	1.14	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

7. Electrical characteristics

($T_C = 25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
B_{VDSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	--	--	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	--	--	1	μA
I_{GSS}	Gate- Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	--	--	± 100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1.1	1.6	2.5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	--	11	13	$\text{m}\Omega$
R_G	Gate Resistance	$f = 1.0 \text{ MHz}$	--	3.5	--	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	2450	--	pF
C_{oss}	Output Capacitance		--	170	--	pF
C_{rss}	Reverse Transfer Capacitance		--	130	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, R_G = 25 \Omega$ (Note 2,3)	--	15	--	ns
t_r	Turn-On Rise Time		--	72	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	180	--	ns
t_f	Turn-Off Fall Time		--	79	--	ns
Q_g	Total Gate Charge	$V_{DD} = 48 \text{ V}, I_D = 60 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 2,3)	--	52	--	nC
Q_{gs}	Gate-Source Charge		--	11	--	nC
Q_{gd}	Gate-Drain Charge		--	12	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Continuous Source Current	Integral Reverse P-N Junction Diode in the MOSFET	--	--	50	A
I_{SM}	Pulsed Source Current		--	--	200	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_s = 20 \text{ A}$	--	--	1.4	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_s = 30 \text{ A}, dI_F / dt = 100 \text{ A/us}$ (Note 4)	--	20	--	ns
Q_{rr}	Reverse Recovery Charge		--	0.02	--	uC

Notes:

1. $L = 10\text{mH}, V_{DD} = 50\text{V}, R_G = 10\Omega$, Starting $T_J = 25^\circ\text{C}$
2. Pulse Test : Pulse width $\leq 300\text{us}$, Duty cycle $\leq 2\%$
3. Essentially independent of operating temperature

8. Typical Characteristics

Figure 1. Output Characteristics

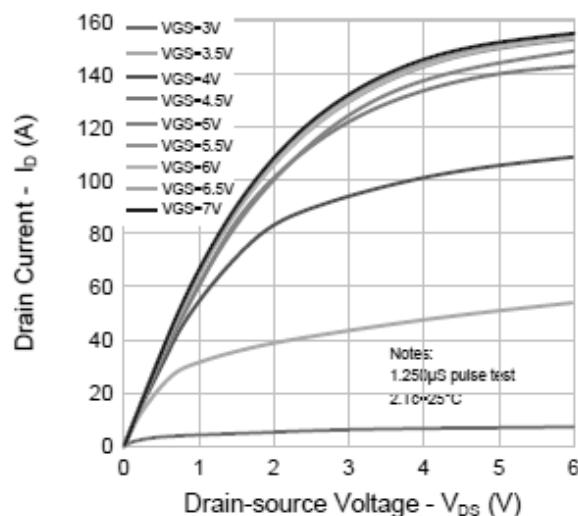


Figure 3. On-resistance vs. Drain Current

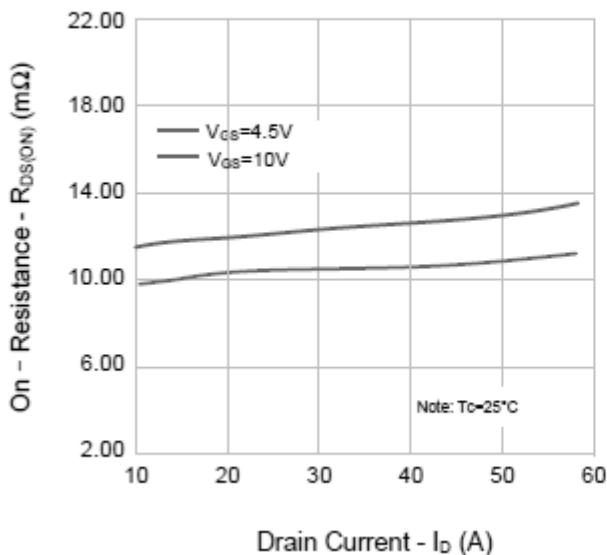


Figure 5. Capacitance Characteristics

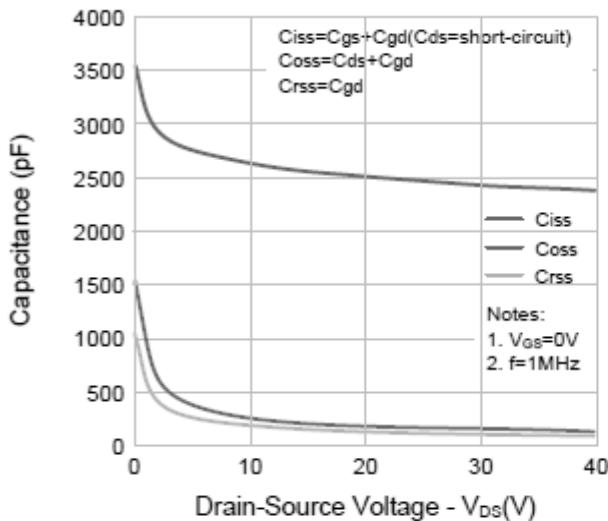


Figure 2. Transfer Characteristics

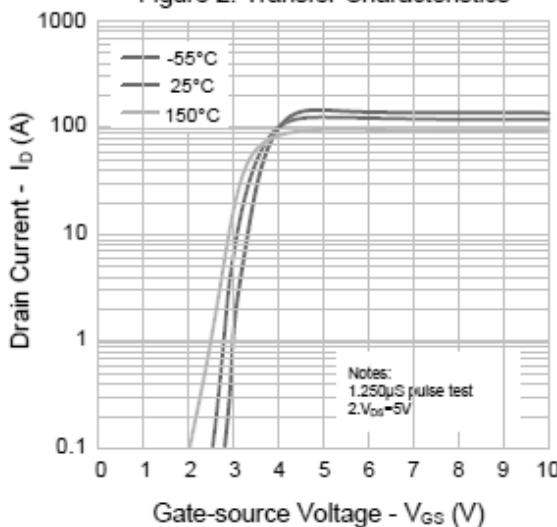


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

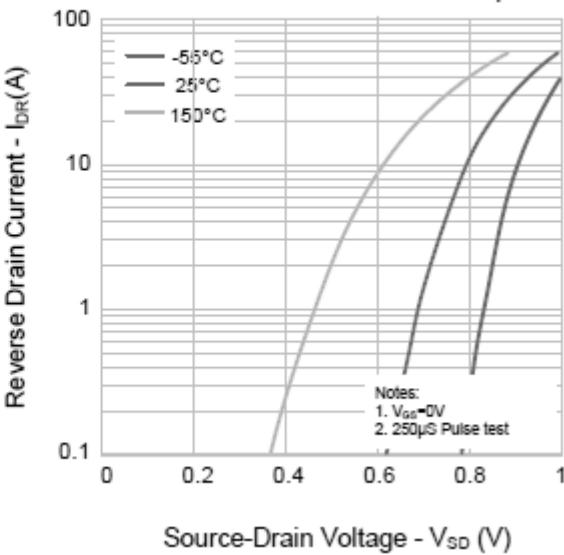


Figure 6. Gate Charge

